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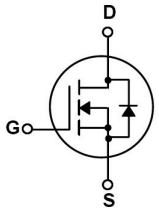

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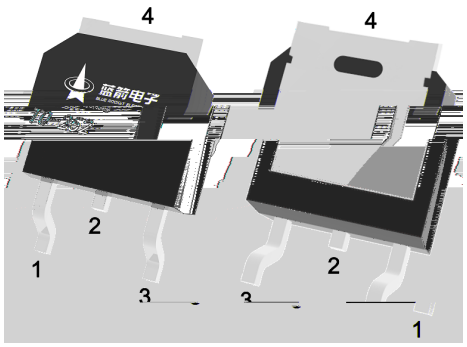

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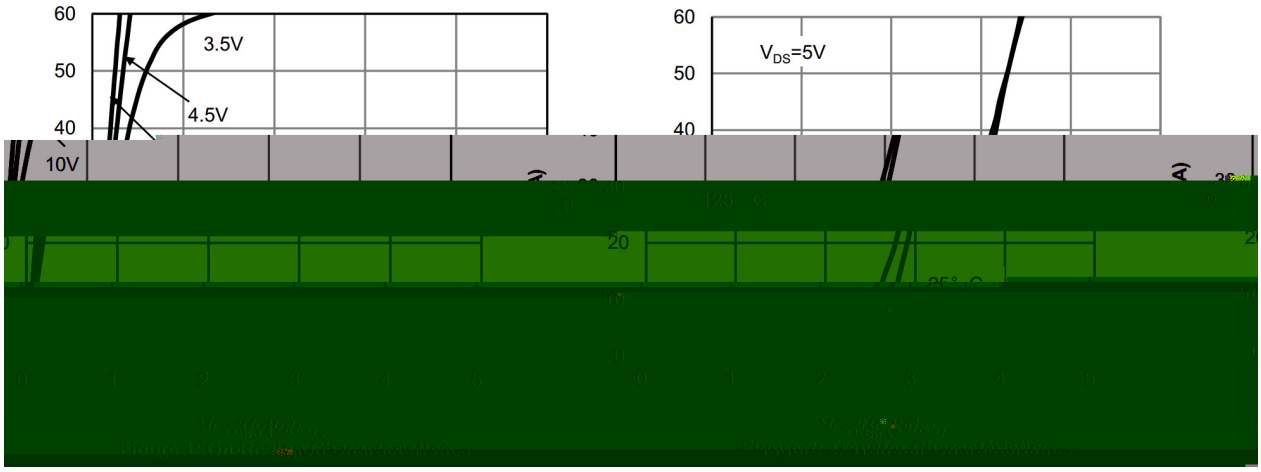
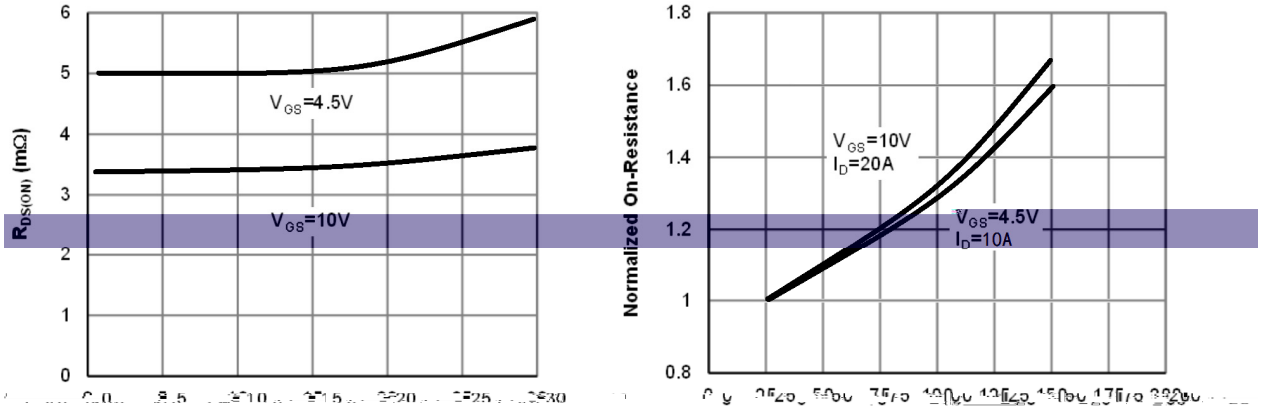
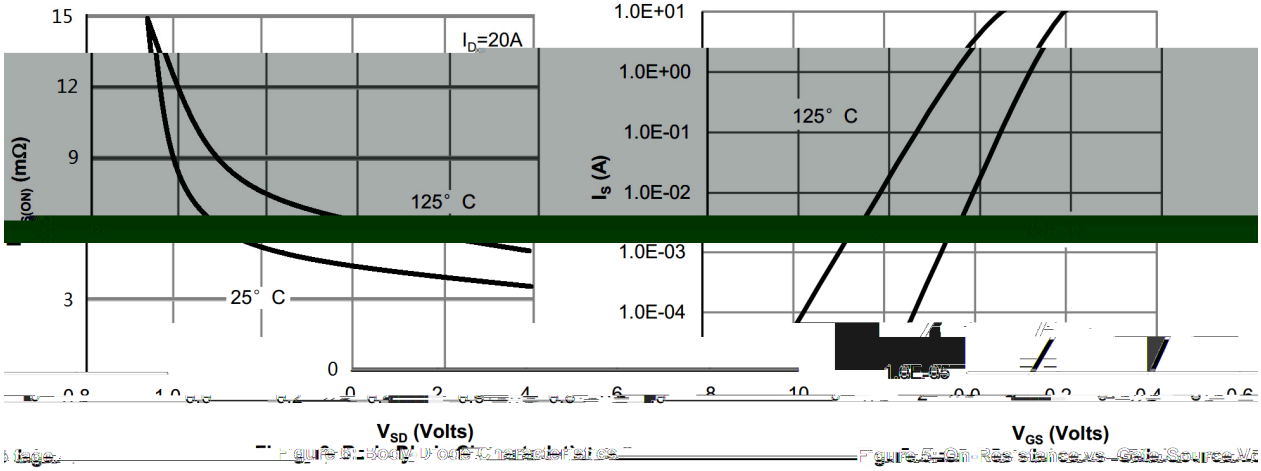




Temperature (°C)
Figure 4: On-Resistance vs. Junction Temperature

I_D (A)
Figure 3: On-Resistance vs. Drain Current and Gate Voltage



V_{SD} (Volts)
Figure 5: Body Diode Characteristics

V_{GS} (Volts)
Figure 6: On-Resistance vs. Gate-Source Voltage

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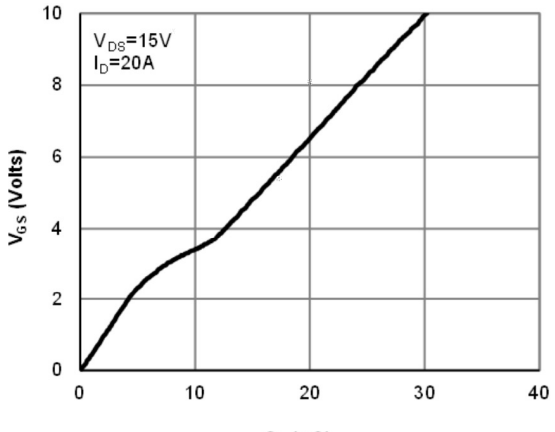


Figure 7: Gate-Charge Characteristics

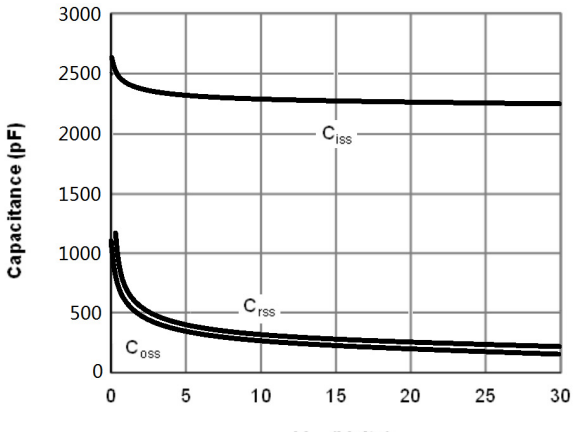
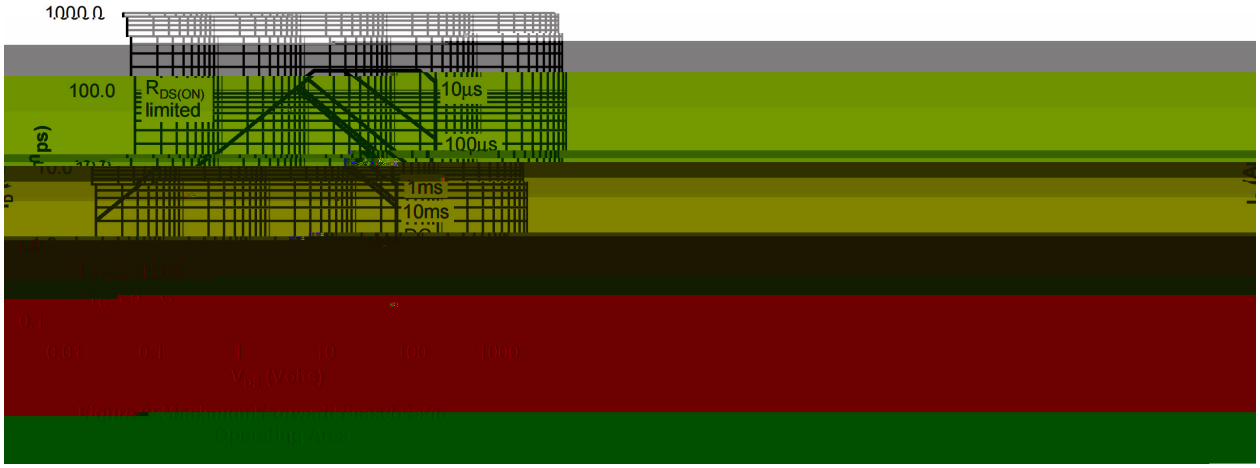


Figure 8: Capacitance Characteristics



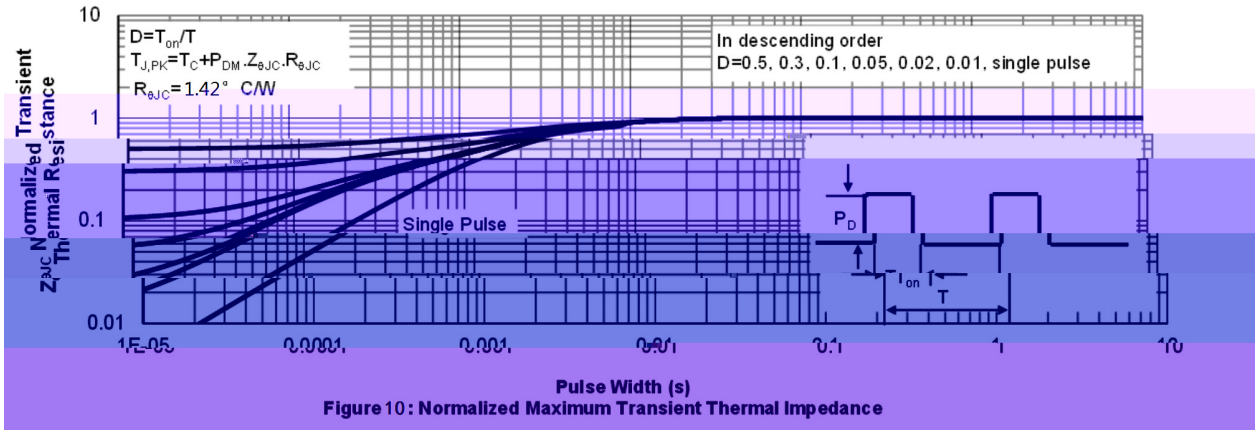


Figure 10 : Normalized Maximum Transient Thermal Impedance

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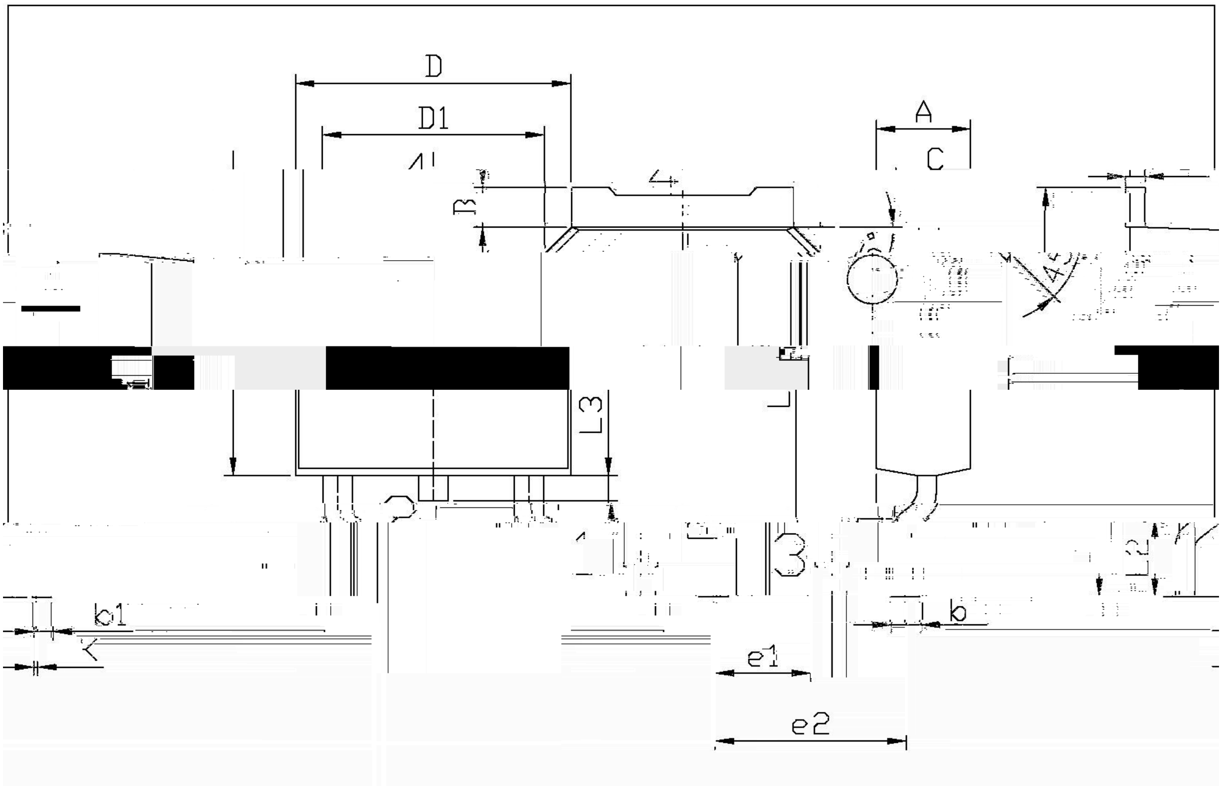

单位：mm

Symbol	Dimensions In Millimeters Min	Dimensions In Millimeters Max	Symbol	Dimensions In Millimeters Min	Dimensions In Millimeters Max
A	2.20	2.40	E	[illegible]	[illegible]
e1	2.24	2.34	B	[illegible]	[illegible]
e2	4.43	4.73	[illegible]	[illegible]	[illegible]
D1	9.85	10.35	b1	[illegible]	[illegible]
C	0.45	0.55	L2	1.70	2.00
D	6.45	6.75	L3	0.60	0.90
[illegible]	5.10	5.50	K	[illegible]	[illegible]

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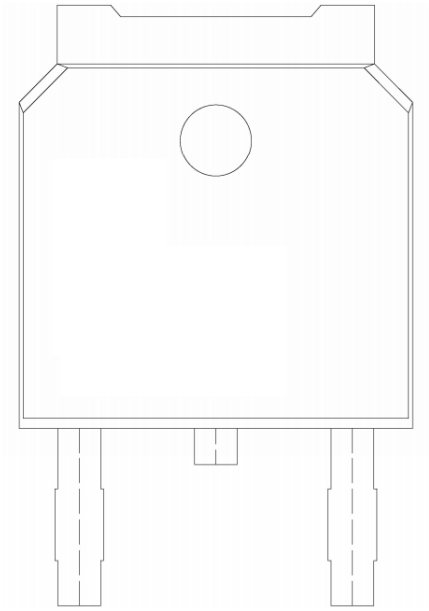

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